

Annealing studies of HPK samples from ATLAS-HGTD run

G. Kramberger, B. Hiti, V. Cindro, A. Howard, Ž. Kljun, I. Mandić, M. Mikuž
Jožef Stefan Institute
in collaboration with ATLAS-HGTD groups

Motivation

- ▶ LGADs are planned for ATLAS High Granularity Timing Detector (HGTD)
- ▶ Lots of studies have been done, but a very large majority of those after 80min@60°C annealing
- ▶ Annealing studies are needed:
 - to predict long term operation and plan operation scenario
 - to know the limits/dangers of possible unplanned events/situations
- ▶ Annealing is important in detector operation
 - almost all detector bulk properties change with annealing (for LGADs these changes can be less important than for standard silicon detectors due to smaller thickness and high bias)
 - annealing could potentially influence initial acceptor removal

Annealing of LGADs

- ▶ We can expect significant decrease of generation current, but in LGADs the total current is the product of gain and I_{gen} so difficult to disentangle both
- ▶ Trapping will be less affected due to small thickness – improvement due to reduced electron trapping

$$\Delta N_{eff} = g_a \Phi_{eq} \exp\left(-\frac{t}{\tau_a}\right) + N_c + g_Y \Phi_{eq} \left(1 - \exp\left(-\frac{t}{\tau_{ra}}\right)\right)$$

$$N_c = \pm N_{id} (1 - \eta (1 - \exp(-c \cdot \Phi_{eq}))) + g_c \Phi_{eq} ,$$

$$V_{fd} = \frac{e_0 |N_{eff}| W^2}{2\epsilon_0 \epsilon}$$

short term annealing
Stable damage

- removal
- deep acceptors

long term/"reverse" annealing

- ▶ What is the impact of short and long term annealing?
 - on bulk (low initial doping)
 - multiplication layer (large initial doping)
- ▶ Does c depend on annealing (I,V reactions with B_s)?
- ▶ If activation energy for reverse annealing is used $E_a = 1.31 \text{ eV}$ then multiplication $t(60^\circ\text{C})/t(20^\circ\text{C}) \sim 510 \rightarrow 1 \text{ day @ } 20^\circ\text{C} \sim 3 \text{ min @ } 60^\circ\text{C}$

What can we expect?

- ▶ **Bulk will be affected** : $g_Y \sim 0.05 \text{ cm}^{-1}$ around 2.5x larger than g_C :

- at $8e14 \text{ cm}^{-2} \rightarrow N_V = 4e13 \text{ cm}^{-3}$ and $N_C = 1.6e13 \text{ cm}^{-3}$
- at $3e15 \text{ cm}^{-2} \rightarrow N_V = 1.5e14 \text{ cm}^{-3}$ and $N_C = 6e13 \text{ cm}^{-3}$

$V_{fd,max} \sim 370 \text{ V}$ (for $3e15 \text{ cm}^{-2}$) $\ll 600 \text{ V}$ required for operation:

- we expect fully active detector
- saturated drift velocities
- **more bulk multiplication**

} bulk will be affected, but at operation point changes should be small

- ▶ **Gain layer** – for $c = 5e-16 \text{ cm}^2$:

- at $8e14 \text{ cm}^{-2} \rightarrow 33\%$ of acceptors are removed
- at $3e15 \text{ cm}^{-2} \rightarrow 78\%$ of acceptors are removed

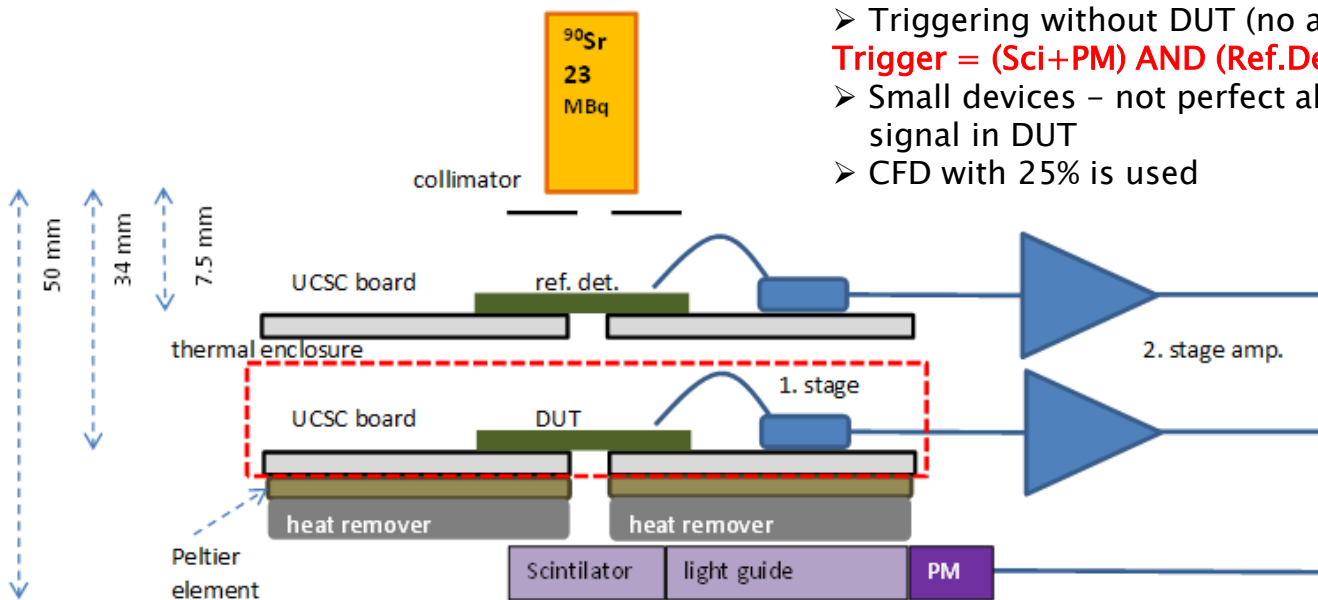
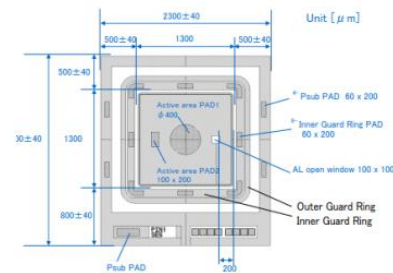
$N_B \sim 1e16 \text{ cm}^{-3} \rightarrow$ can not be much influenced by annealing

} multiplication layer will not be affected significantly

- ▶ We should see a decrease of leakage current with annealing – there is no reverse annealing of leakage current.

Samples, setup and procedures

- ▶ Samples were produced by HPK (LGAD run 4) – different gain layer doses for T3.2, T3.1
 - ▶ 50 um thick substrate,
 - ▶ 1.3x1.3 mm² single pad devices
 - ▶ V_{mr} (foot voltage T3.2) ~55 V (very high initial gain)
 - ▶ V_{mr} (foot voltage T3.1) ~40 V (moderate initial gain)
- T3.2 samples were irradiated to 4 ,8 ,15, 30, 60e14 cm⁻² for annealing studies and to intermediate fluences for consistency (2.25,4,5e15 cm⁻²)
 - T3.1 samples were irradiated to 15, 30e14 cm⁻²
- After irradiations the samples were annealed in steps to 2600 min @ 60C. Between the steps the timing/CCE performance of the system was measured at -30°C.

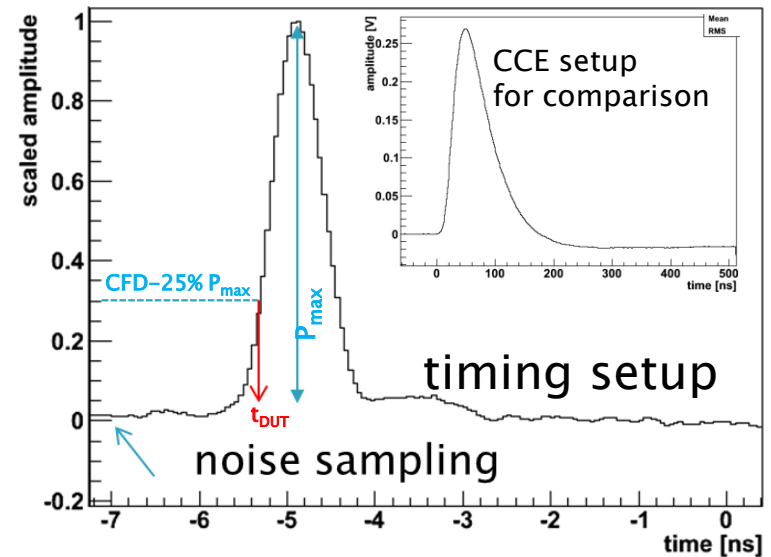
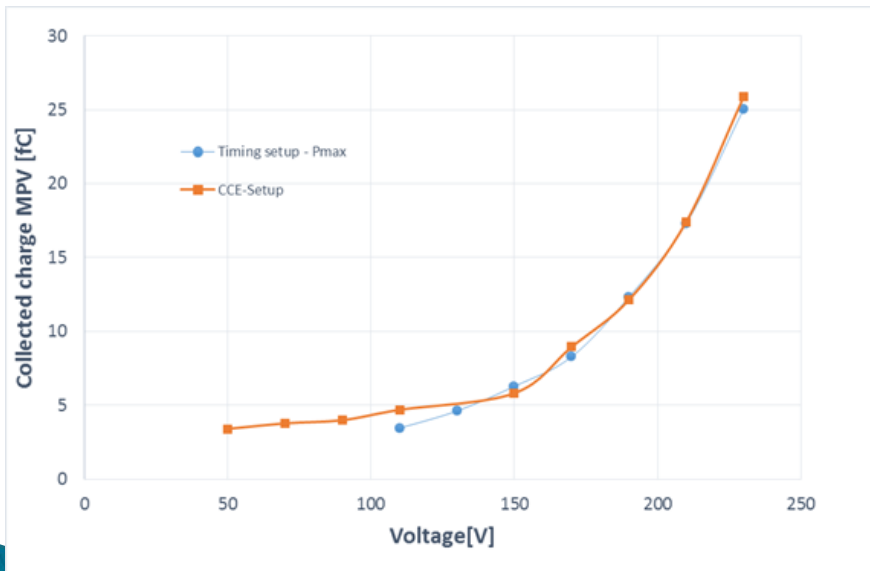


- ▶ Triggering without DUT (no analysis bias introduced by that):
Trigger = (Sci+PM) AND (Ref.Det)
- ▶ Small devices – not perfect alignment (30–40% of trigger have signal in DUT)
- ▶ CFD with 25% is used

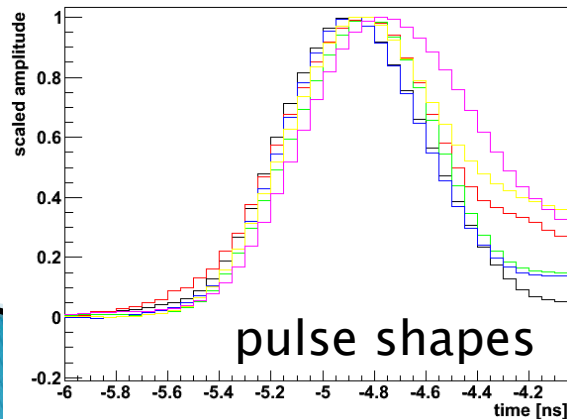
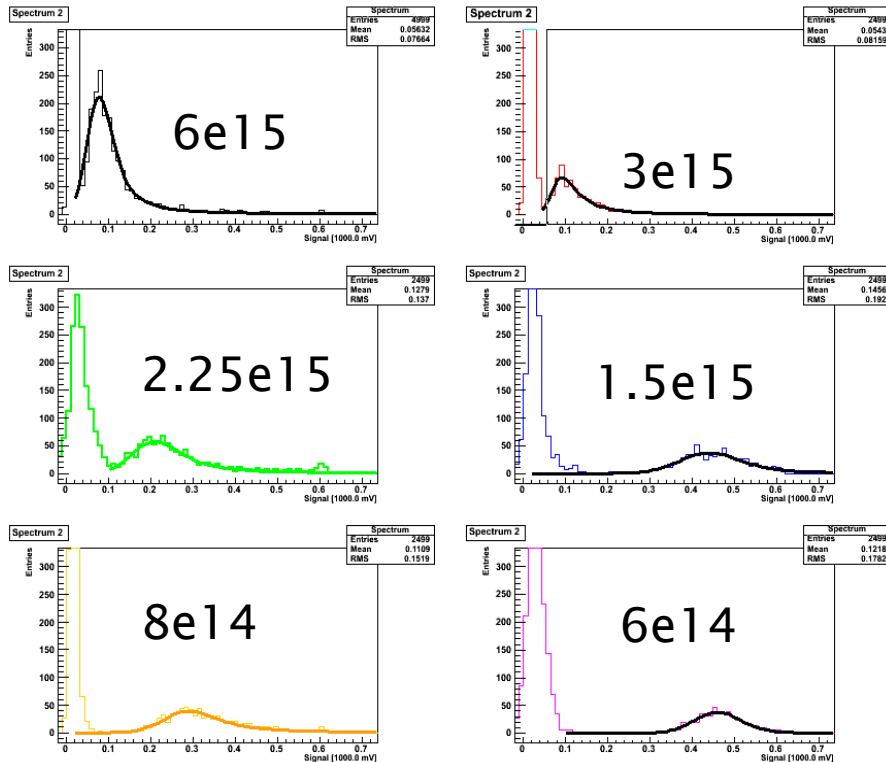
The humidity was monitored and the dew point was always well below the operation temperature (dry air ventilation)

Calibration of the system

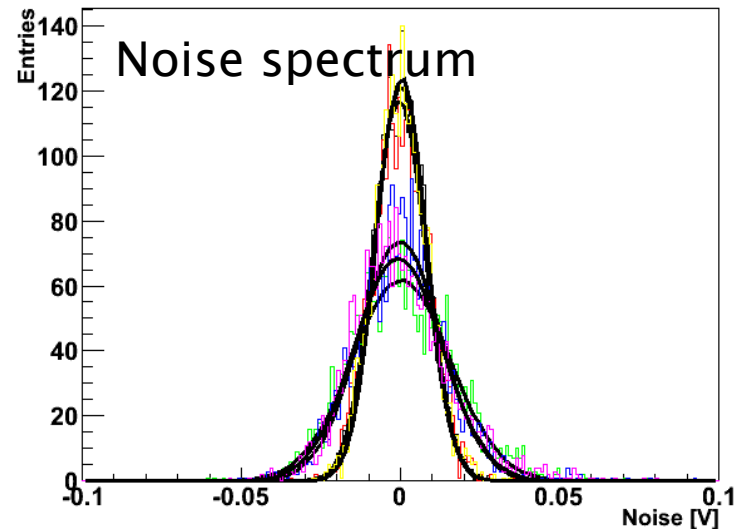
- ▶ The system was calibrated using a non-irradiated device of Type 3.1 which was operable at room temperature
- ▶ Ljubljana CCE system (preamp+25 ns shaping circuit) was used which is precisely calibrated with standard silicon detector with ^{90}Sr and ^{241}Am 60 keV photons
- ▶ P_{max} scale was converted to fC using the calibration.
- ▶ The charge scale of the timing system was also verified using 3D detector, which was fast (P_{max} is proportional to the collected charge) and was thick enough so that S/N is good.
- ▶ most probable signal of ^{90}Sr electrons in 50 μm thick detector was ~ 3100 e which agrees well with expected 63 e-h/ μm from literature



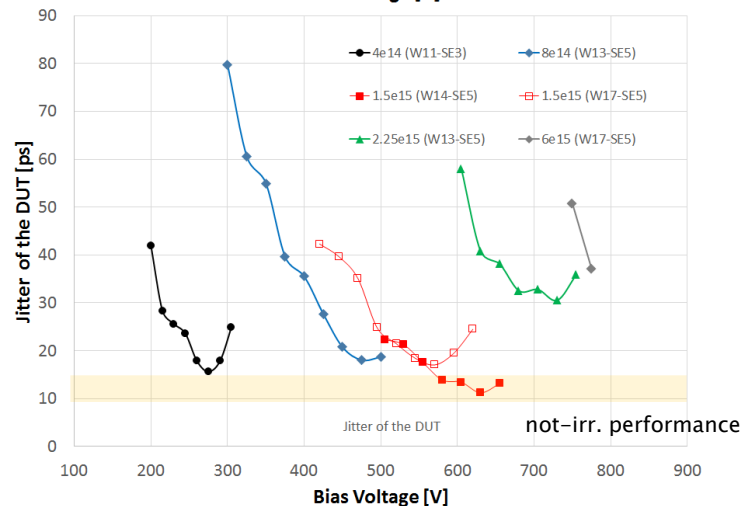
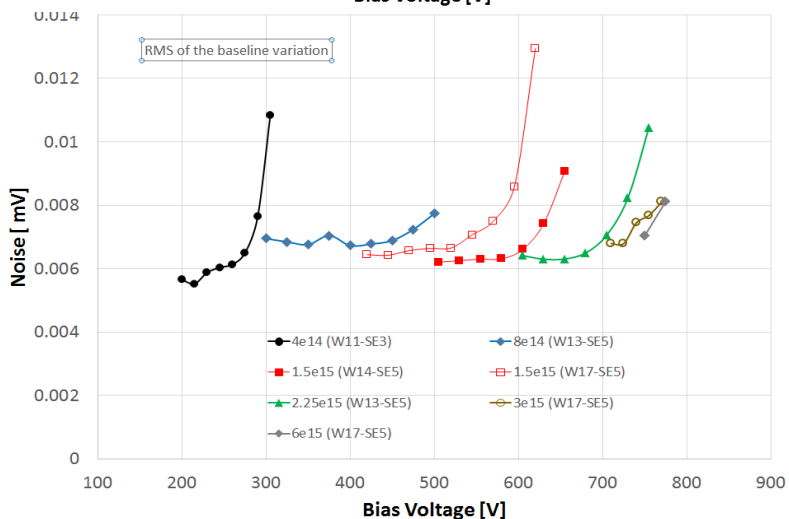
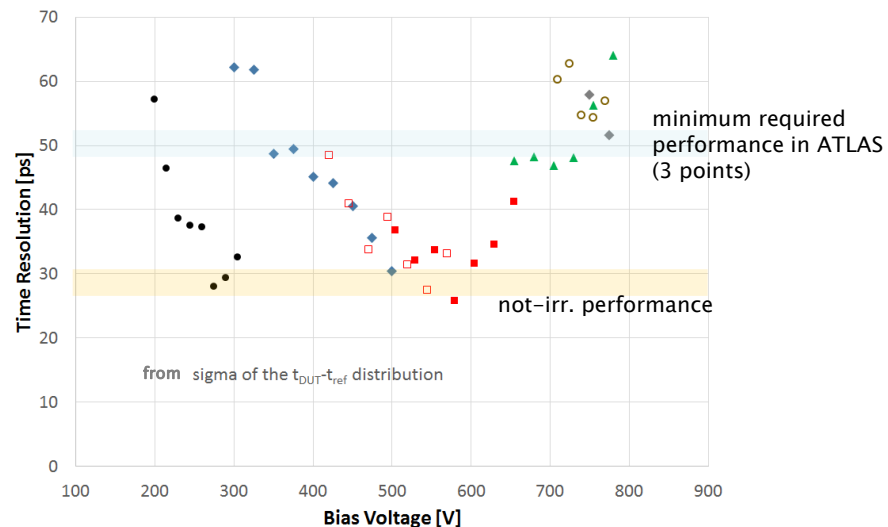
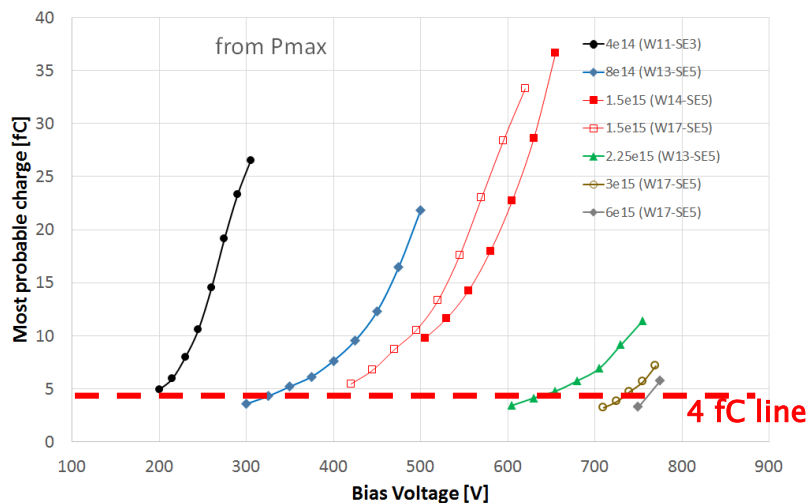
Analysis in short



- ▶ Spectrum of P_{max} was recorded and fitted with convolution of Landau&Gauss (LG)
- ▶ MPV/timing was determined only for those measurements where it was clear peak separation.
- ▶ In addition it was required that the integral of LG (number of events) is approximately the same in the voltage scan (it depends only on the alignment)
- ▶ The trigger condition also removed all the possible “ghost” triggers
- ▶ Noise, rise time, jitter ... were all monitored during the measurements



Results at standard annealing point (I)

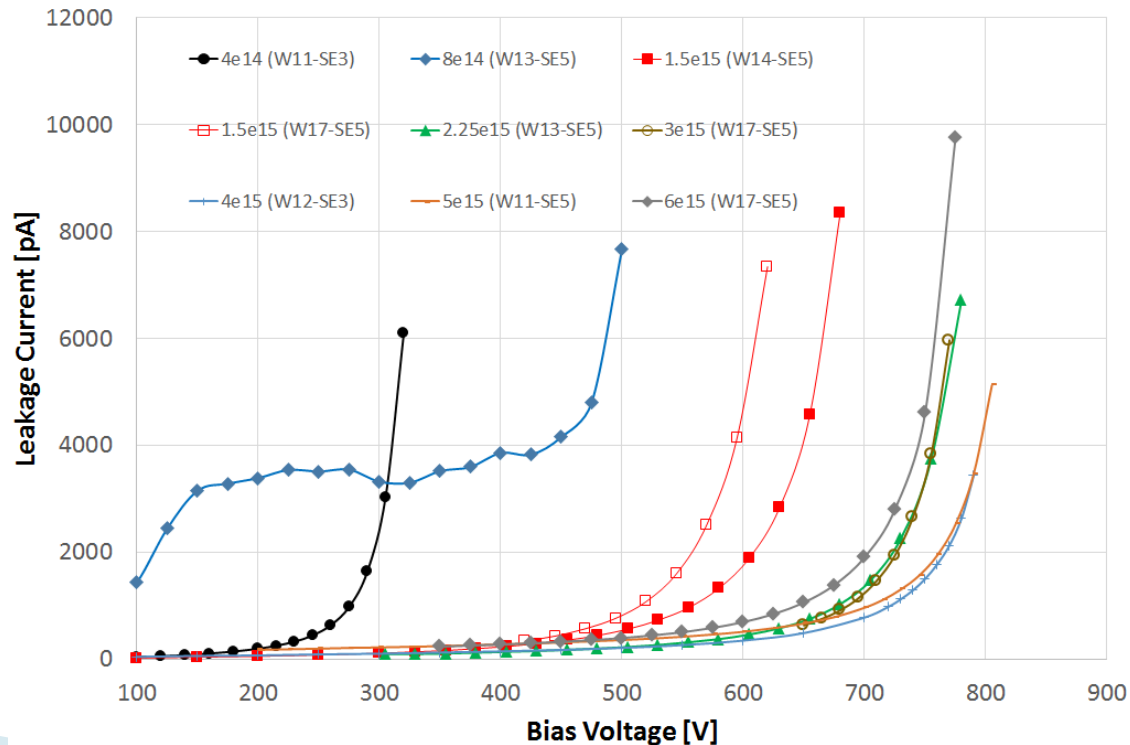


2.25e15 cm⁻² after 80min@60 all
other after 120 min@60°C

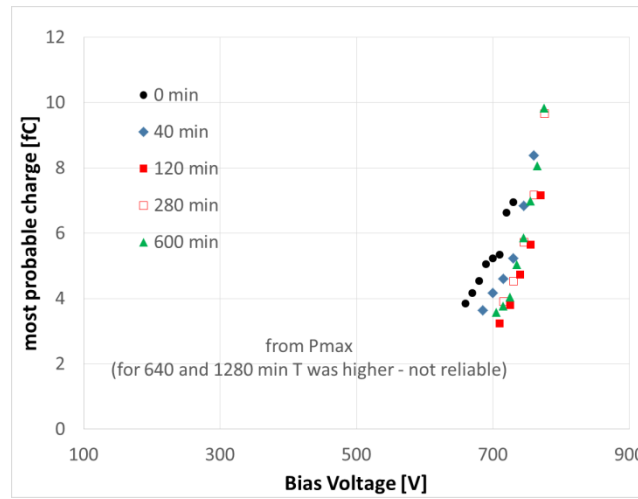
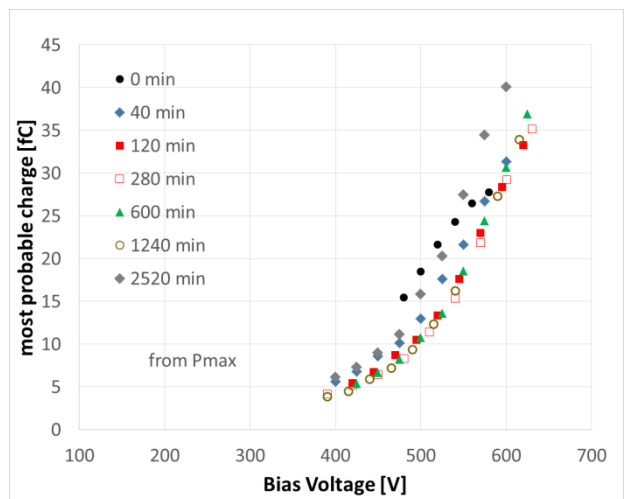
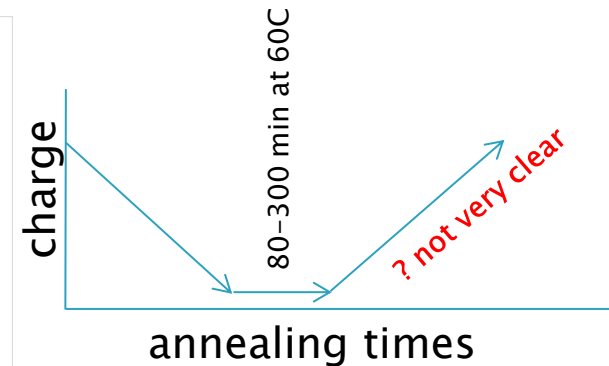
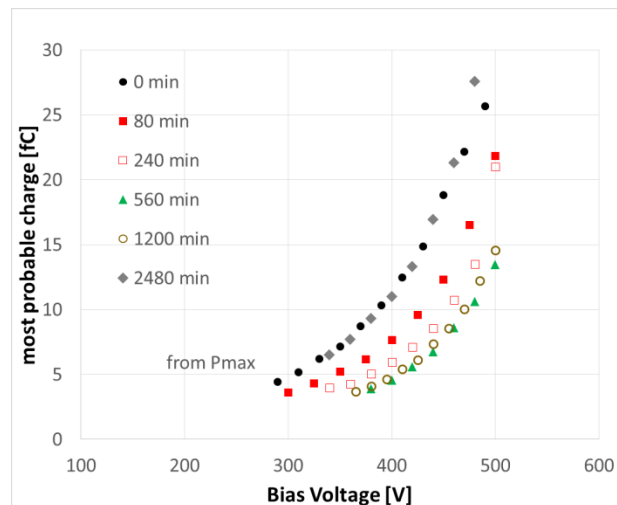
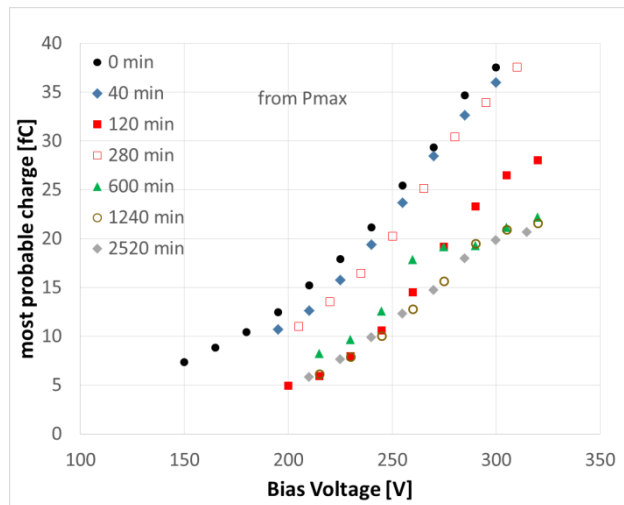
- ▶ Good performance of Type 3.2 sensors, but they can not be operated so close to break down (safety margin is required)
- ▶ Noise increases once the “break down”/large increase in gain appears and spoils resolution
- ▶ **There is quite sizeable difference in performance of same detectors irradiated to same fluence (see 1.5e15 cm⁻²), which can have various reasons: small fluence variation can play a role, humidity, long term biasing at high voltages - under investigation in ATLAS**

Results at “standard” annealing point (II)

- ▶ The shape of the IV for $8e14 \text{ cm}^{-2}$ is not clear, but we mount/unmount and it remains (probably GR effect)
- ▶ The $4e15$ and $5e15 \text{ cm}^{-2}$ were also measured, but we couldn't see the Landau peak – hence not analyzed – there must be a correlation between low current/low gain seen in this plot
- ▶ At $6e15 \text{ cm}^{-2}$ we measured only at 40 min annealing as the device broke down at 80 min due to very high voltage applied.
- ▶ The IV curves get steeper at larger fluences and are shifted to high bias voltages → that leaves less voltage headroom



Annealing effects for Type 3.2 (charge)



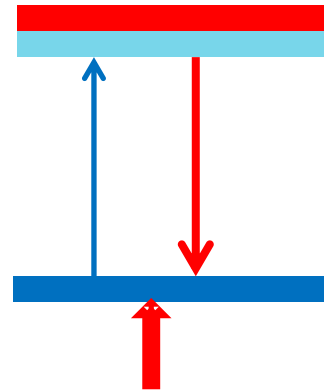
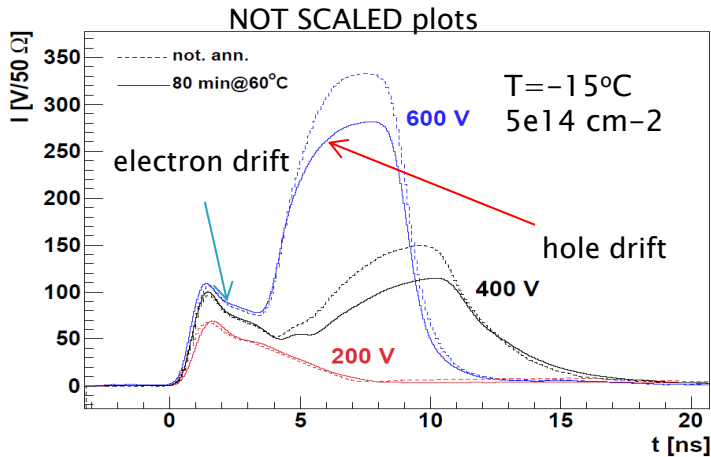
- ▶ Annealing effects are not very large (expected)
- ▶ The slope of the QV is even more important than mere charge, which can be translated to larger voltage required
- ▶ Most of the measurements done so far actually present the “worst case scenario” → 80min @ 60°C
- ▶ Similar behavior – with less detectors studied was also observed for CNM detectors
- ▶ **Type 3.2 sensors have very “fluctuating behavior”**

Is the decrease of CC with short term annealing due to:

- reduction of the bulk N_{eff} and related smaller field?
- acceptor removal “reverse” annealing in gain layer?

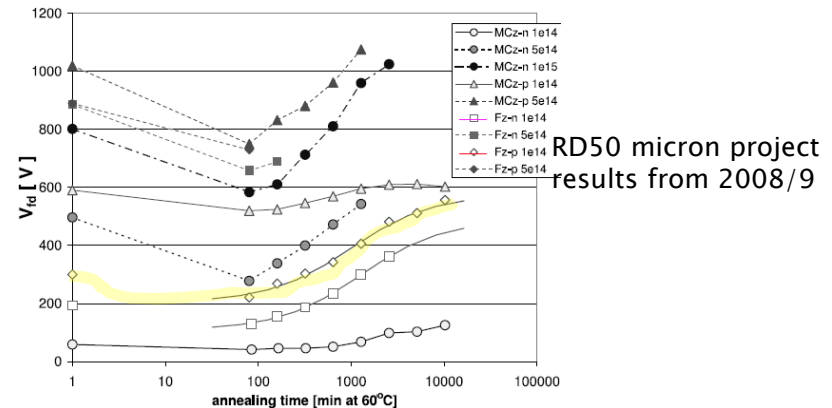
Reasons for CC annealing behavior

An example of gain layer – acceptor removal annealing on 300 μm thick Ga LGADs samples from CNM irradiated with neutrons (NIM A 898 (2018) 53–59)

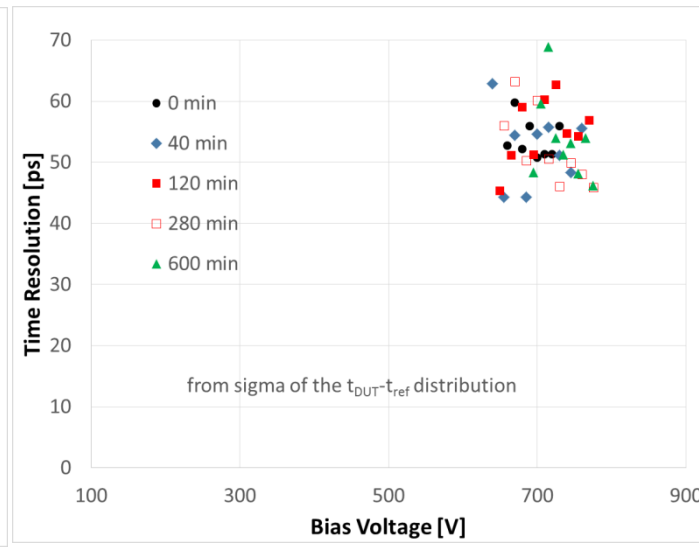
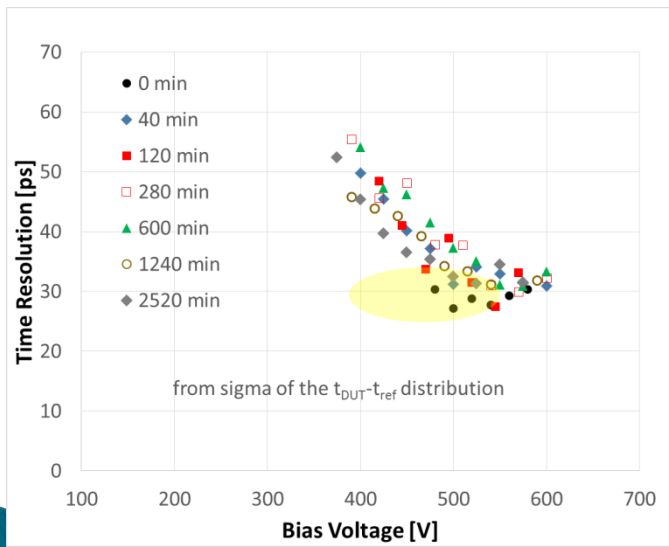
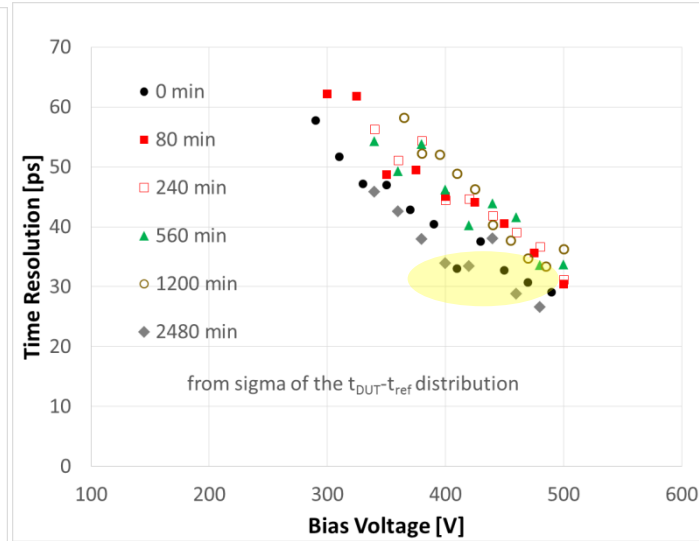
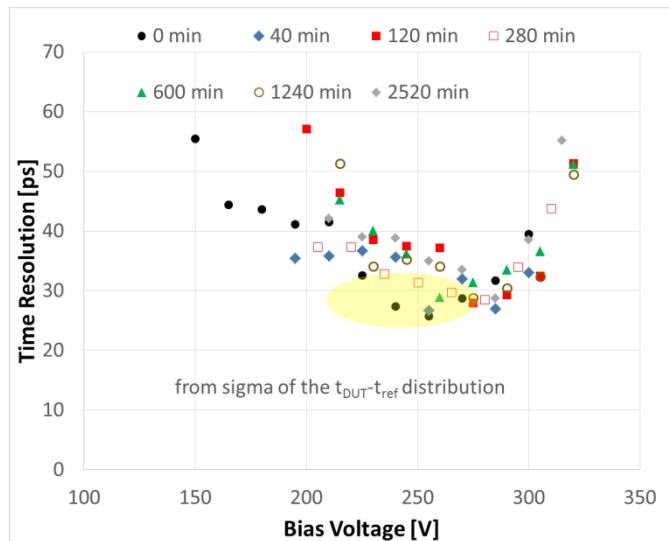


Equal signal after electron drift and reduced gain is a strong indication that “reverse” annealing of acceptor removal is the main reason, **but these measurements should be repeated!**

- Bulk N_{eff} after ~2500 min should be much larger than that after irradiation – so if the bulk would be the main reason we should see larger gain after annealing than before annealing
- That bulk is not dominant can be seen at $4e14$ where reverse annealing of N_{eff} is not enough to produce back the initial gain – gain remains low at 2520 min
- Gain increase after long term annealing clearly seen in ATLAS strip detectors (JSI, Freiburg)

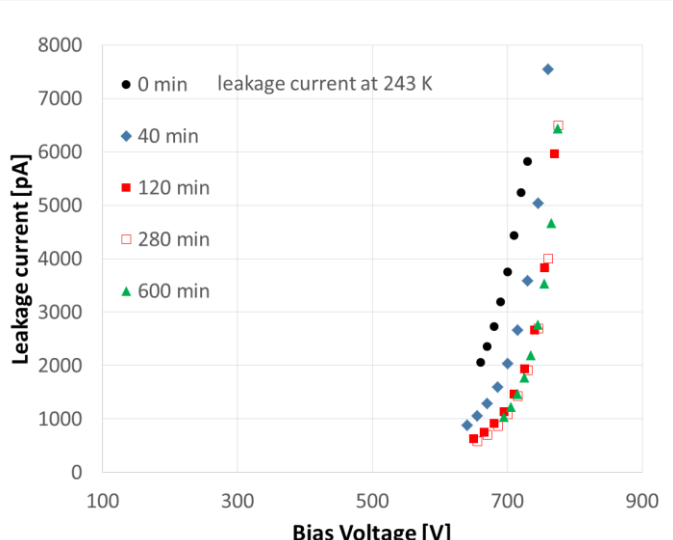
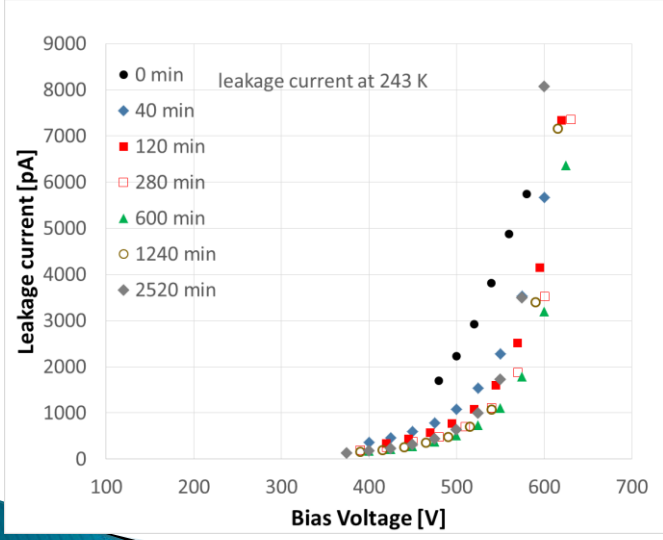
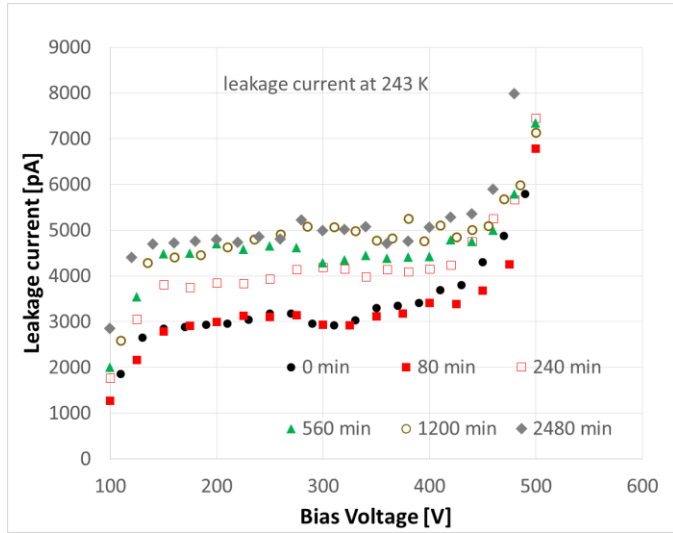
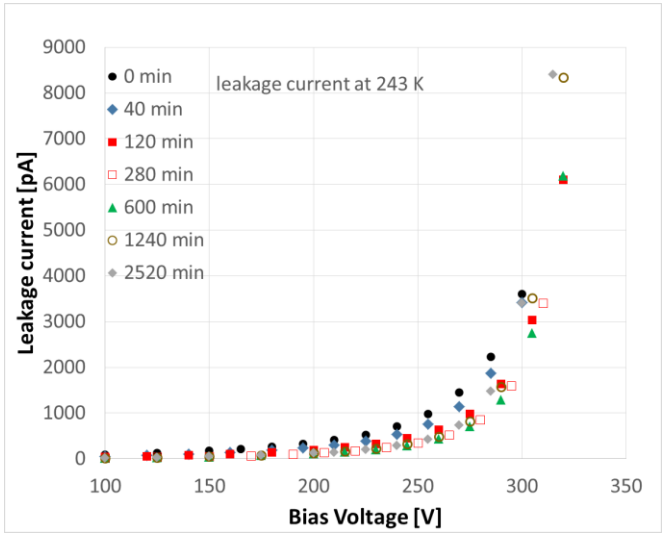


Annealing effects for Type 3.2 (time resolution)



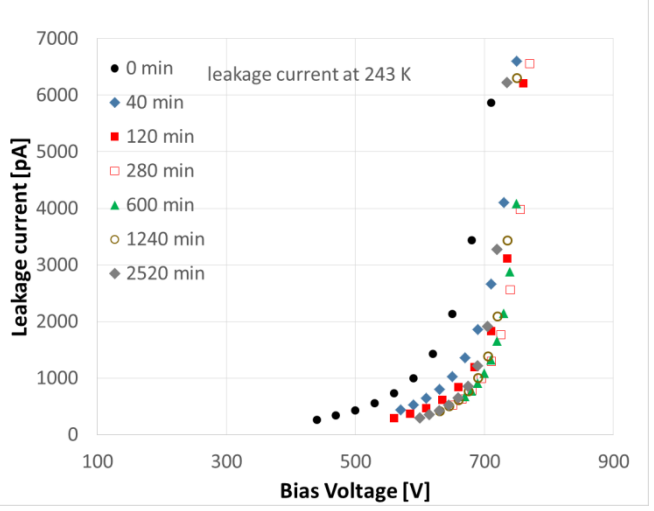
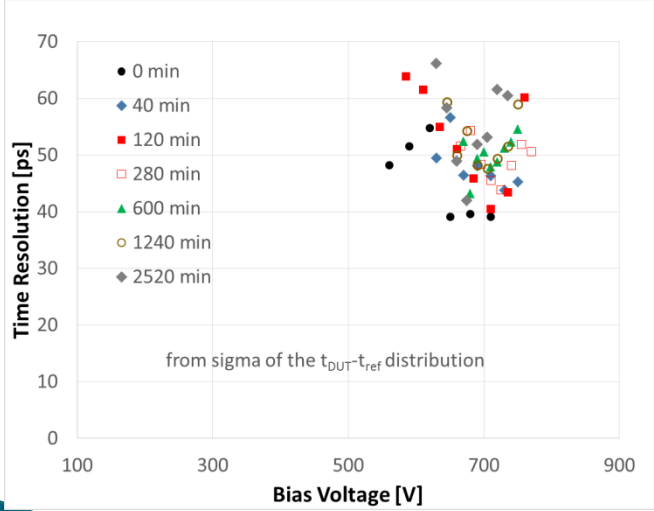
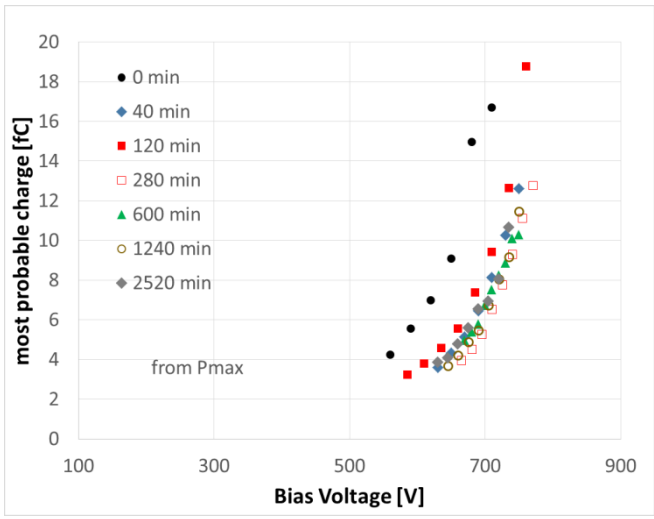
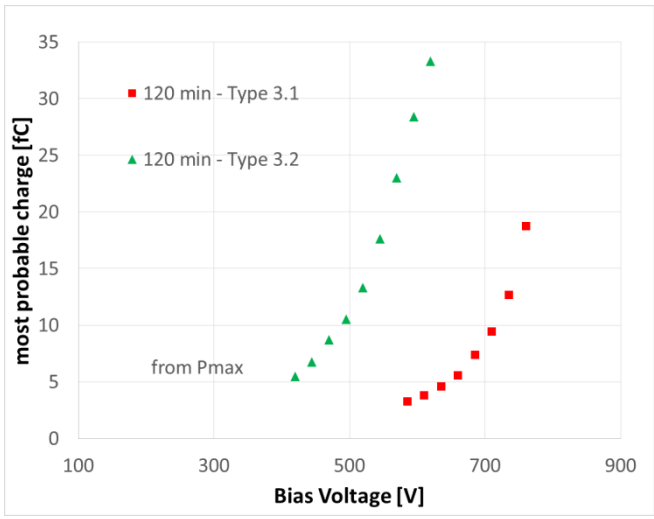
- ▶ The annealing of the charge collection is loosely translated to the time resolution
- ▶ 30 ps can be reached sooner in terms of voltage for lower fluences
- ▶ for $3e15 \text{ cm}^{-2}$ it wasn't possible to clearly separate peaks in the spectrum – data are missing. Reason is probably that we couldn't cool the detectors below -22C .

Annealing effects for Type 3.2 (leakage current)



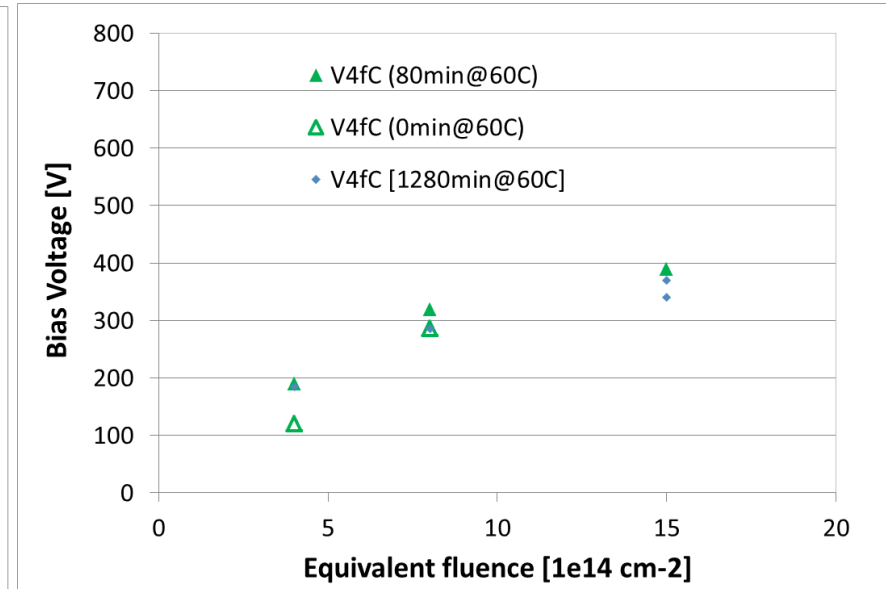
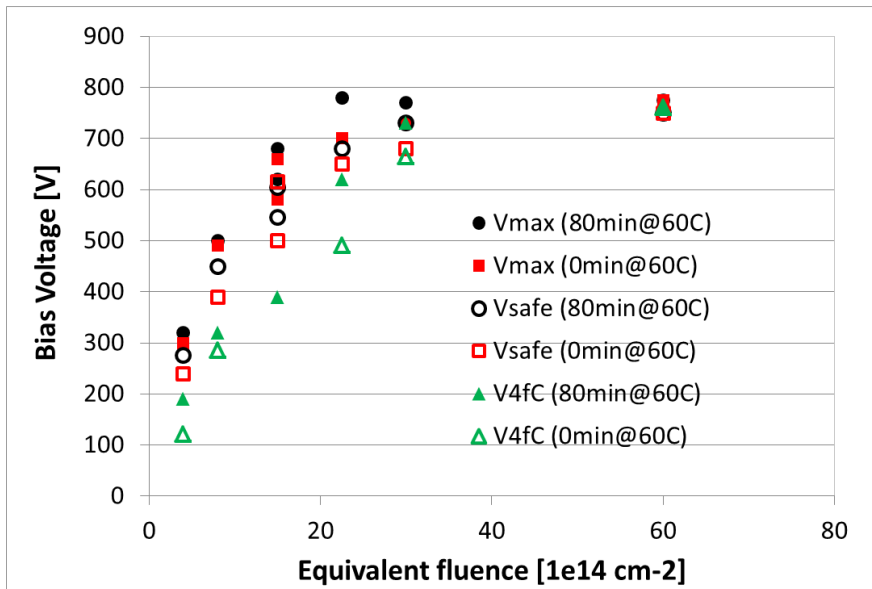
- ▶ The shape of the IV for $8 \times 10^{14} \text{ cm}^{-2}$ is not clear, but it seems some kind of GR effect – increase of the current with annealing
- ▶ As expected the leakage current decreases with annealing, due to annealing of generation current – most notable at the first points of the Sr90 measurement

Annealing effects for Type 3.1 ($1.5e15 \text{ cm}^{-2}$)



- ▶ Type 3.1 have smaller gain at larger fluences than Type 3.2 as the initial gain layer doping is smaller
- ▶ The worse performance is reflected also in time resolution
- ▶ As for Type 3.2 better performance before annealing

Summary



- ▶ up to $\sim 2.5 \times 10^{15} \text{ cm}^{-2}$ the operation seems to be safe – far enough from break down
- ▶ for $> 3 \times 10^{15} \text{ cm}^{-2}$ the QV becomes very steep and all “voltages” are very close together – unsafe
- ▶ “Standard annealing” actually shows worst case for V4fC (voltage at 4 fC) – in terms CC and bias voltage required except at lower fluences where the depletion of the detector bulk requires significant voltage drop.
- ▶ **annealing of gain layer has to be better understood → separate TCT measurements are needed for that** (NIM A 898 (2018) 53–59)

Conclusions

Annealing of HPK Type 3.2/3.1 diodes (narrow and highly doped gain layer) were studied

- ▶ The impact of annealing on timing and CC is not very strong in the range of our interest (0–2600 min @ 60°C)
- ▶ QV plots are shifted to lower bias voltages immediately after annealing and also at very long annealing times (worse at ~100 min @ 60°C)
 - short term annealing is associated with less initial dopants (needs to be studied by TCT to confirm that)
 - long term annealing improvement is associated with more bulk gain
- ▶ Annealing current anneals as expected and improves the power consumption
→ in that sense longer annealing would be beneficial for operation at HL-LHC